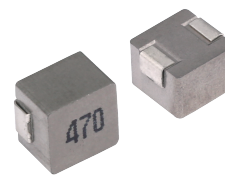


FEATURES

- Powder iron core material
- Magnetically shielded, low EMI
- High current carrying capacity, Low core losses
- Frequency range up to 3MHz
- Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (Including self temp. rise)
- RoHS compliant



APPLICATIONS

- Voltage Regulator Module (VRM)
- Multi-phase regulators
- Point-of-load modules
- Smart phone POL modules
- SSD modules
- Notebook regulators
- Battery power systems
- Graphics cards
- Data networking and storage systems

PRODUCT IDENTIFICATION

FSA1350 -1R0 M T

1 2 3 4 5

1:Product Series:Metal Alloy Molding Power Inductor

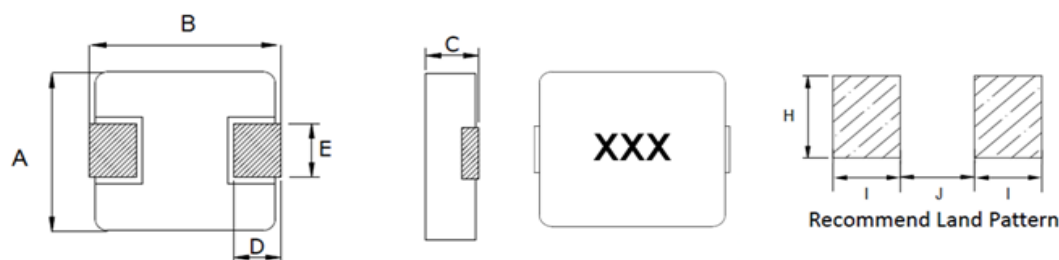
2:Dimensions:

3: Initial inductance value: 1R0 = 1.0uH

4:Tolerance of Inductance:M:±20%

5:Packing:Tape Carrier Package

Dimensions: [mm]



Series	A	B	C	D	E	I Typ.	J Typ.	H Typ.
FSA1350	12.6±0.3	13.45±0.35	4.8±0.2	2.0±0.5	See Remarks	3.25	8.0	5.5

Series	E(mm)	Dimensions
FSA1350	3.85±0.5	R22/R36/R50/R68/R82/1R0/1R5/2R2
	5.0±0.3	3R3/4R7/6R8/100/150/220/330/470

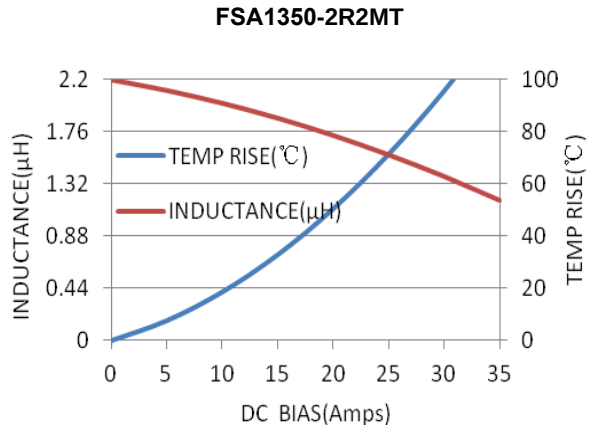
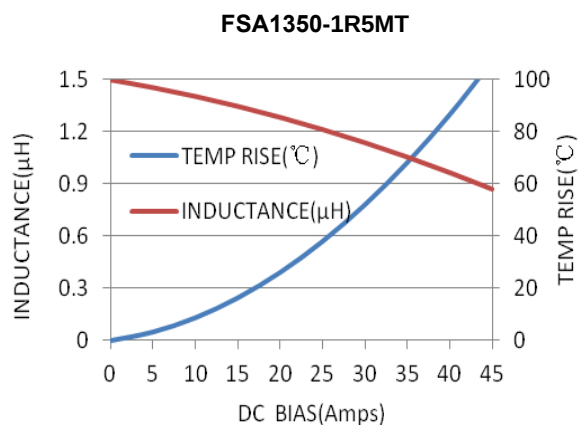
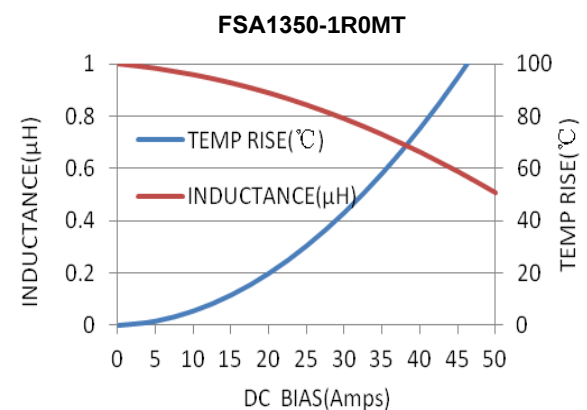
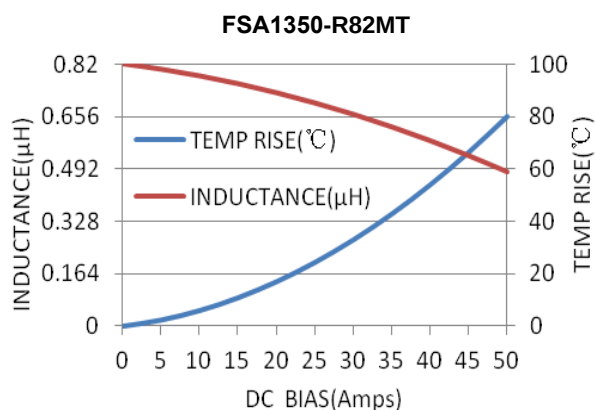
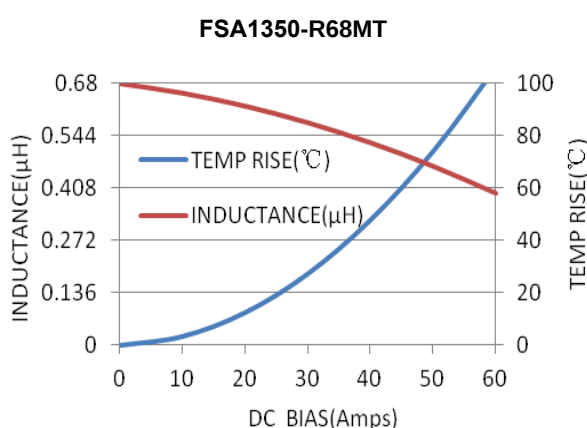
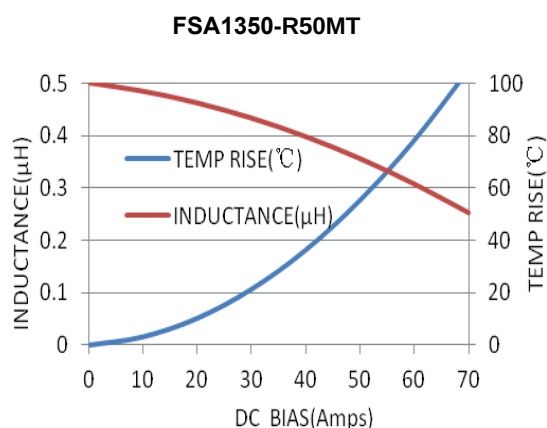
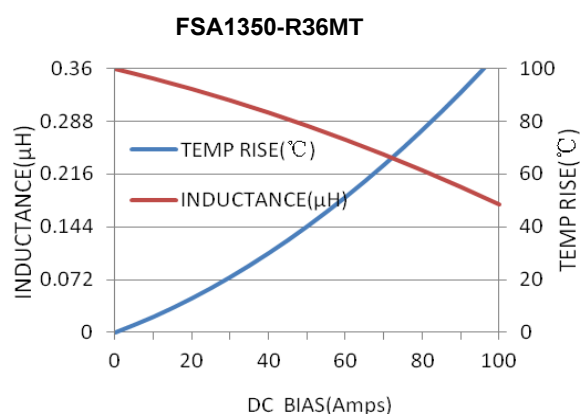
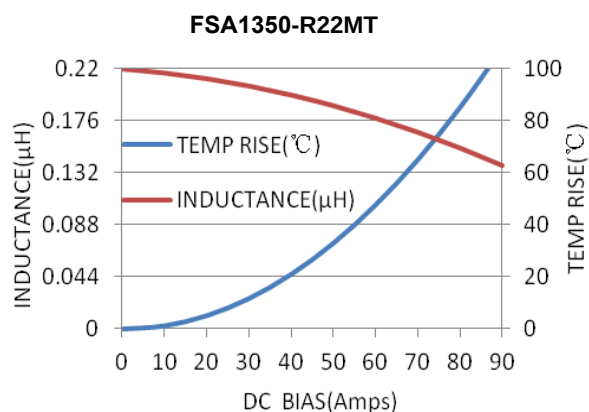
Electrical Properties:

Part Number	Inductance	DC Resistance	Saturation Current		Heat Rating Current	
	@100KHz,1V	Max.	Max.	Typ.	Max.	Typ.
Units	μH	mΩ	A		A	
Symbol	L	DCR	Isat		Irms	
FSA1350-R22MT	0.22±20%	0.7	60.0	75.0	45.0	50.0
FSA1350-R36MT	0.36±20%	0.85	40.0	50.0	37.0	42.0
FSA1350-R50MT	0.50±20%	1.15	38.4	48.0	33.0	38.0
FSA1350-R68MT	0.68±20%	1.55	36.8	46.0	29.0	33.0
FSA1350-R82MT	0.82±20%	1.67	31.2	39.0	26.0	30.0
FSA1350-1R0MT	1.0±20%	2.2	28.0	35.0	22.0	26.0
FSA1350-1R5MT	1.5±20%	3.2	26.4	33.0	19.0	23.0
FSA1350-2R2MT	2.2±20%	5	19.2	24.0	13.0	15.0
FSA1350-3R3MT	3.3±20%	7	17.6	22.0	12.0	14.0
FSA1350-4R7MT	4.7±20%	9	16.0	20.0	11.0	13.0
FSA1350-6R8MT	6.8±20%	18	12.8	16.0	10.0	12.0
FSA1350-100MT	10±20%	22	9.60	12.0	8.00	9.00
FSA1350-150MT	15±20%	30	8.00	10.0	7.00	8.00
FSA1350-220MT	22±20%	58	5.20	6.50	3.80	4.50
FSA1350-330MT	33±20%	84	4.80	6.00	2.80	3.50
FSA1350-470MT	47±20%	130	4.00	5.00	2.60	3.00

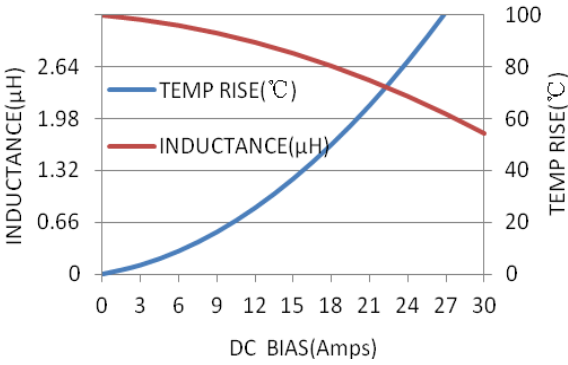
Notes

- ※1: All test data is referenced to 20°C ambient;
- ※2: Rated current: Isat or Irms, whichever is smaller;
- ※3: Isat(Typ): DC current at which the inductance drops approximate 30% from its value without current;
- ※4: Isat(Max): DC current at which the inductance drops approximate 20% from its value without current;
- ※5: Irms(Typ): DC current that causes the temperature rise ($\Delta T = 40^{\circ}\text{C}$) from 20°C ambient.
- ※6: Irms(Max): DC current that causes the temperature rise ($\Delta T = 20^{\circ}\text{C}$) from 20°C ambient.
- ※7: Absolute maximum voltage 30VDC

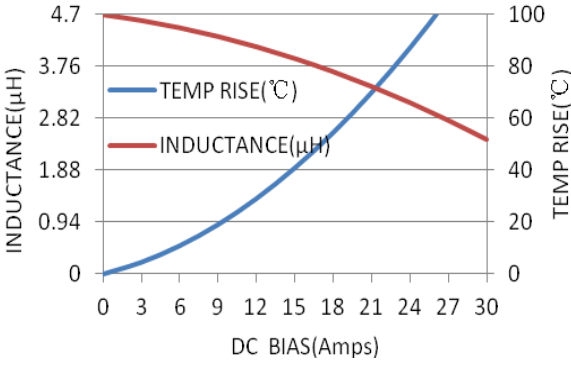
TYPICAL ELECTRICAL CHARACTERISTICS



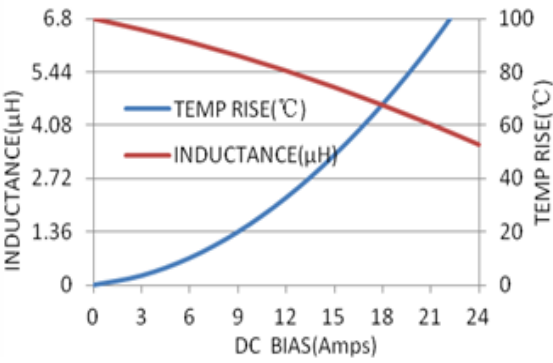
FSA1350-3R3MT



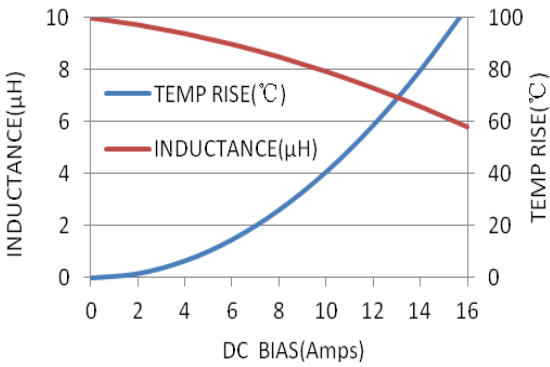
FSA1350-4R7MT



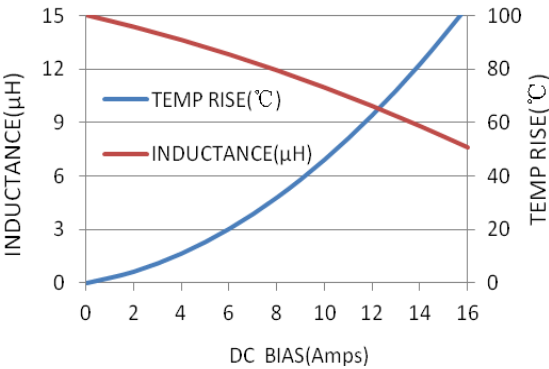
FSA1350-6R8MT



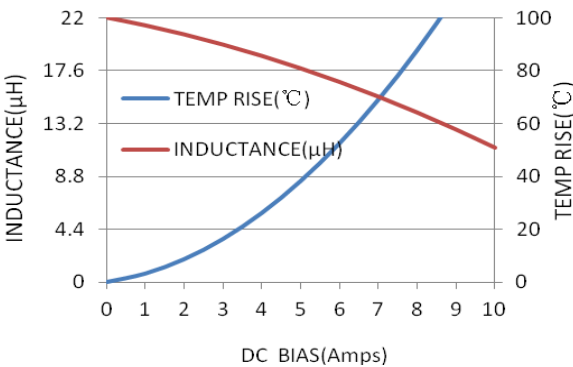
FSA1350-100MT



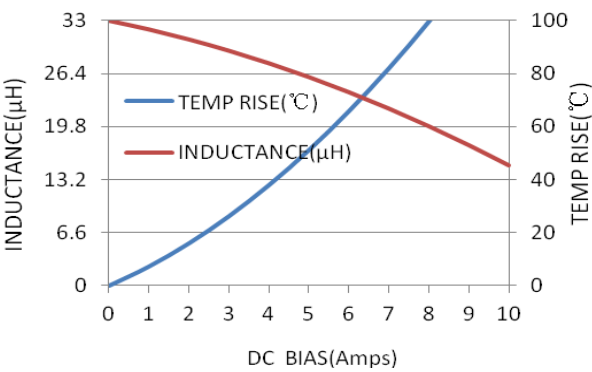
FSA1350-150MT



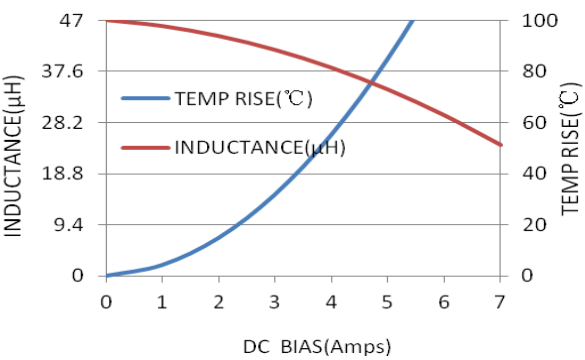
FSA1350-220MT



FSA1350-330MT



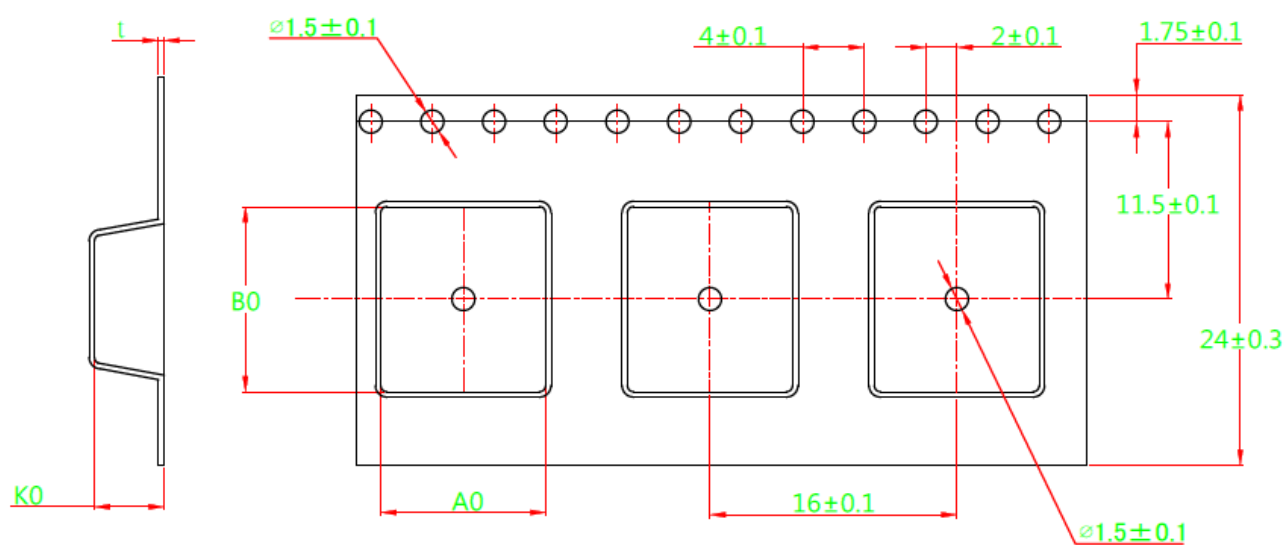
FSA1350-470MT



Reliability and Test Condition

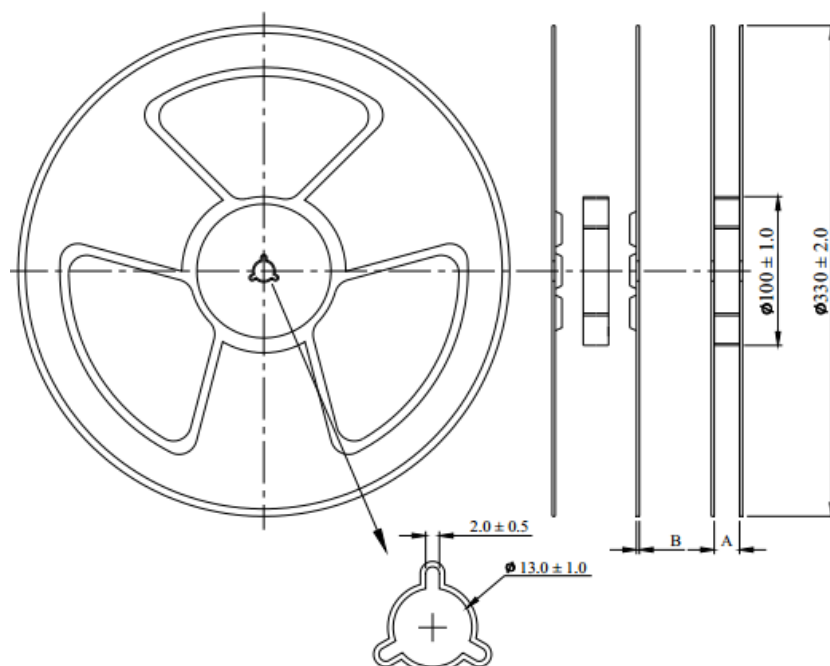
Mechanical Reliability		
Item	Specification and Requirement	Test Method
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	Solder heat proof: 1. Preheating: $160 \pm 10^{\circ}\text{C}$ 2. Retention time: $245 \pm 5^{\circ}\text{C}$ for 2 ± 0.5 seconds
Vibration	Inductance change: Within $\pm 10\%$ Without mechanical damage such as break	1. Vibration frequency: (10 Hz to 55 Hz to 10Hz) in 60 seconds as a period 2. Vibration time: Period cycled for 2 hours in each of 3 mutual perpendicular directions. 3. Amplitude: 1.5 mm max.
Shock	Inductance change: Within $\pm 10\%$ Without mechanical damage such as break	1. Peak value: 100 G 2. Duration of pulse: 11ms 3. 3 times in each positive and negative direction of 3 mutual perpendicular directions
Endurance Reliability		
Item	Specification and Requirement	Test Method
Thermal Shock	Inductance change: Within $\pm 10\%$ Without distinct damage in appearance	1. Repeat 100 cycles as follow: ($-55 \pm 2^{\circ}\text{C}$; 30 ± 3 min) → (Room temp., 5 min) → ($+125 \pm 2^{\circ}\text{C}$, 30 ± 3 min) → (Room temp., 5 min) 2. Recovery: $48 \pm 4 / -0$ hours of recovery under the standard condition after the test.
High Temperature Resistance	Inductance change: Within $\pm 10\%$ Without distinct damage in appearance	1. Environment condition: $85 \pm 2^{\circ}\text{C}$ Applied Current: Rated current 2. Duration: $1000 \pm 4 / -0$ hours
Humidity Resistance	Inductance change: Within $\pm 10\%$ Without distinct damage in appearance	1. Environment condition: $60 \pm 2^{\circ}\text{C}$ Humidity: 90–95% Applied Current: Rated current 2. Duration: $1000 \pm 4 / -0$ hours
Low Temperature Store	Inductance change: Within $\pm 10\%$ Without distinct damage in appearance	Store temperature: $-55 \pm 2^{\circ}\text{C}$, $1000 \pm 4 / -0$ hours
High Temperature Store	Inductance change: Within $\pm 10\%$ Without distinct damage in appearance	Store temperature: $+125 \pm 2^{\circ}\text{C}$, $1000 \pm 4 / -0$ hours

Tape Packaging Dimensions



A0	B0	K0	t
13.4 ± 0.10	14.4 ± 0.10	5.4 ± 0.15	0.5 ± 0.05

Reel Dimensions



	A	B
mm	24.5 ± 0.2	2.0 ± 0.2

Packaging Quantity: 500PCS/Reel

Recommended Soldering Technologies

(1) Re-flowing Profile

Preheat condition: 150 ~200°C/60~180sec.

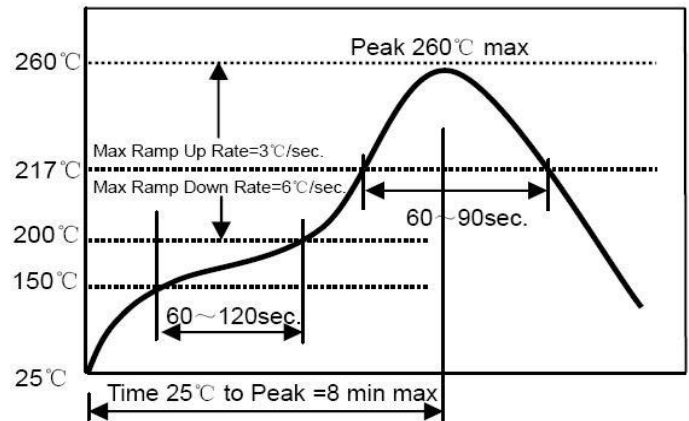
Allowed time above 217°C: 80~120sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



(2) Iron Soldering Profile

Iron soldering power: Max.

30W Pre-heating: 150°C/60sec.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

Max.1 times for iron soldering

